Form P 10-1505

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Attorney Docket No. 8013-1204

U.S. Department of Commerce U.S. Patent and Trademark Office

To the Honorable Commissioner of Patents and Trademarks; Please record the attached original documents or copy thereof. Name of Conveying Party(ies): 2. Name and address of receiving party(ies) Noriyuki FUTAGAWA Name: **NEC Corporation** Address: 7-1, Shiba 5-chome Minato-ku Takyo Additional name(s) of conveying party(les) attached? 108-8001 ☐ Yes ⊠ No Japan 3. Nature of Conveyance: Additional name(s) and address(ss) attached? ☐ Yes Ø No Assignment Merger Security Agreement Change of Name Other: Execution Date: January 14, 2004 4. Application number(s) or patent number(s): This document is being filed with a new application, the execution date of the application is: January 14, 2004 A. Patent Application No(s). В. Patent No(s). 10/503,269 Additional numbers attached? Yes 5. Name and address of party to whom correspondence Total number of applications and patents concerning document should be mailed: involved: 1 Customer No.: 00466 7. Total fee (37 CFR 3.41).....\$40.00 YOUNG & THOMPSON Enclosed Second Floor Authorized to be charged to deposit account

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To the best of my knowledge and belief, the foregoing information is true and correct and any attached copy

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Yolanda Reynolds

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Docket No.

ASSIGNMENT

WHEREAS.

Norlyuki FUTAGAWA

hereafter referred to as "applicant(s)", have invented certain new and useful improvements in Quantum well structure and semiconductor device using it and manufacturing method of semiconductor device

- (a) for which an application for a United States patent was filed on August 2, 2004 Application No. 10/503,269
- for which an application for a United States patent was executed on (b)

WHEREAS, NEC Corporation.

whose address is 7-1, Shiba 5-chome, Minato-ku, Tokyo 108-8001, JAPAN,

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hereinafter referred to as "assignee(s)", is desirous of acquiring the entire right, title and interest in and to the same.

NOW, THEREFORE, in consideration of the sum of Ten Dollars (\$10.00), the receipt whereof is acknowledged, and other good and valuable consideration, applicant(s), by these presents, do(es) hereby sell, assign and transfer unto said assignee(s) the full and exclusive right to the said invention in the United States and the entire right, title and interest in and to any and all patents which may be granted therefore in the United States, for its sole use and behoof, and for the use and behoof of its legal representatives, to the full end of the term for which said patents may be granted, as fully and entirely as the same would have been held by applicant(s) had this assignment and sale not been made.

Applicant(s) hereby authorize(s) and request(s) the Commissioner of Patents and Trademarks to issue said United States patents to said assignee(s).

Date 14 January 2004,

Moriyufi Fuxagama (signature) Noriyuki FUTAGAWA

PATENT

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